

## Refine Search

### Search Results -

Terms	Documents
L3 and L4 and L5 and L6	87

Database:

US Pre-Grant Publication Full-Text Database  
 US Patents Full-Text Database  
 US OCR Full-Text Database  
 EPO Abstracts Database  
 JPO Abstracts Database  
 Derwent World Patents Index  
 IBM Technical Disclosure Bulletins

Search:

L7 ▲  
▼





### Search History

DATE: Monday, April 02, 2007    [Purge Queries](#)    [Printable Copy](#)    [Create Case](#)

**Set Name**    **Query**  
 side by side

**Hit Count**    **Set Name**  
 result set

*DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ*

<u>L7</u>	l3 and l4 and l5 and L6	87	<u>L7</u>
<u>L6</u>	428/413,414,500.ccls.	7922	<u>L6</u>
<u>L5</u>	conductive (filler or particle)	34666	<u>L5</u>
<u>L4</u>	layer	4202980	<u>L4</u>
<u>L3</u>	adhesive	1242268	<u>L3</u>

*DB=USPT; PLUR=YES; OP=ADJ*

<u>L2</u>	6034331[pn]	1	<u>L2</u>
<u>L1</u>	6328844[pn]	1	<u>L1</u>

END OF SEARCH HISTORY